

We claim:

1. A photosensitive laminate structure comprising at least:
  - a) an ink receptive, radiation transmissive layer; and
  - b) at least one photosensitive resist layer.
2. The photosensitive laminate structure of claim 1, further comprising a carrier layer.
3. The photosensitive laminate structure of claim 2, wherein the carrier layer comprises polyester, biaxially oriented polypropylene, high density polyethylene, low density polyethylene, or other polymer films.
4. The photosensitive laminate structure of claim 1, wherein the ink receptive, radiation transmissive layer is water-soluble.
5. The photosensitive laminate structure of claim 1, wherein the ink receptive, radiation transmissive layer is removable from the photosensitive resist layer upon exposure to water.
6. The photosensitive laminate structure of claim 1, wherein the ink receptive, radiation transmissive layer has anti-block properties.
7. The photosensitive laminate structure of claim 1, wherein the ink receptive, radiation transmissive layer is receptive to inkjet ink.





22. The photosensitive laminate structure of claim 21, wherein the membrane layer comprises polyvinyl alcohols, polyvinyl butyral, polyvinyl formal, polyurethane, nitrocellulose, a polyvinyl pyrrolidone copolymer, and urethane acrylic polymers.

23. A method of forming a relief pattern in a photoresist substrate, the method comprising:

- a) providing a photosensitive laminate structure comprising at least an ink receptive, radiation transmissive layer, and at least one photosensitive resist layer formed into a single, photosensitive laminate;
- b) printing a pattern on the ink receptive, radiation transmissive layer;
- c) exposing the laminate to actinic radiation to modify the photosensitive resist layer; and
- d) removing a portion of the photosensitive resist layer corresponding to the pattern formed on the ink receptive, radiation transmissive layer.

24. The method according to claim 23, further comprising removing the ink receptive, radiation transmissive layer.

25. The method according to claim 24, wherein the ink receptive, radiation transmissive layer is removed following application of water.